

Quick Reference

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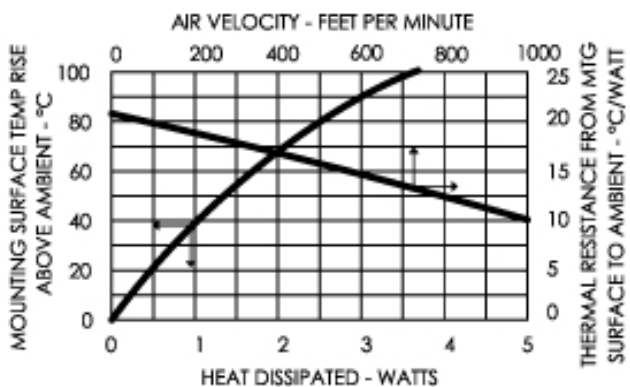
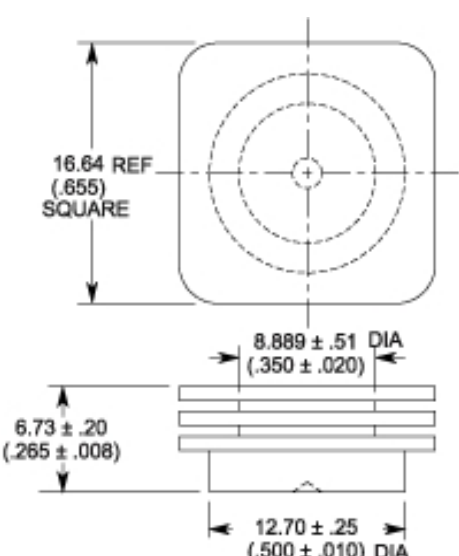
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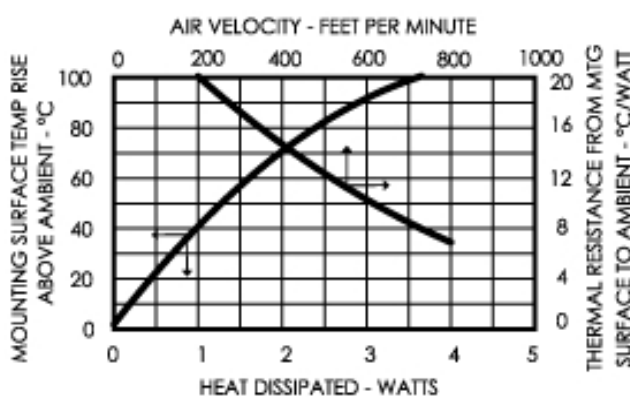
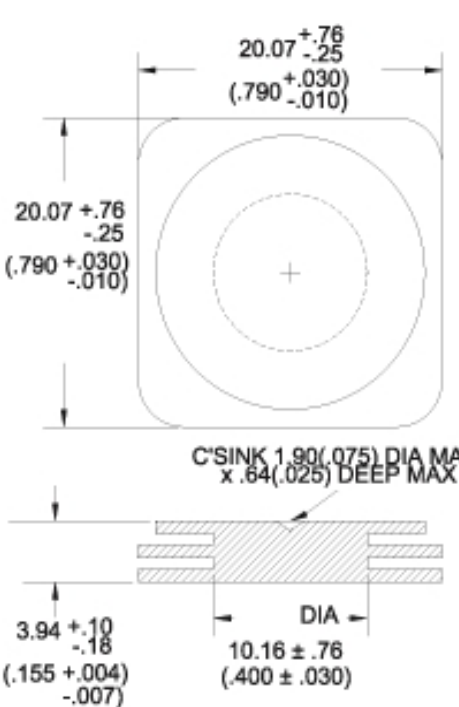
Radial Fin Heat Sinks for Microprocessors

- ? Bond - on heat sinks for leadless chip carriers and flat packs.
- ? Primarily designed for 68 - position devices.
- ? The 2283 is ideally suited to limited board space applications with high air flow.

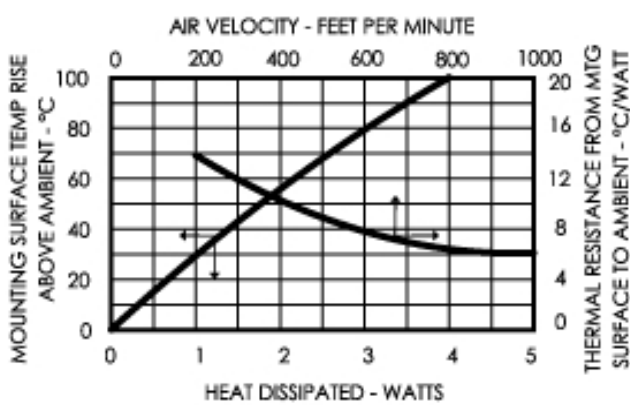
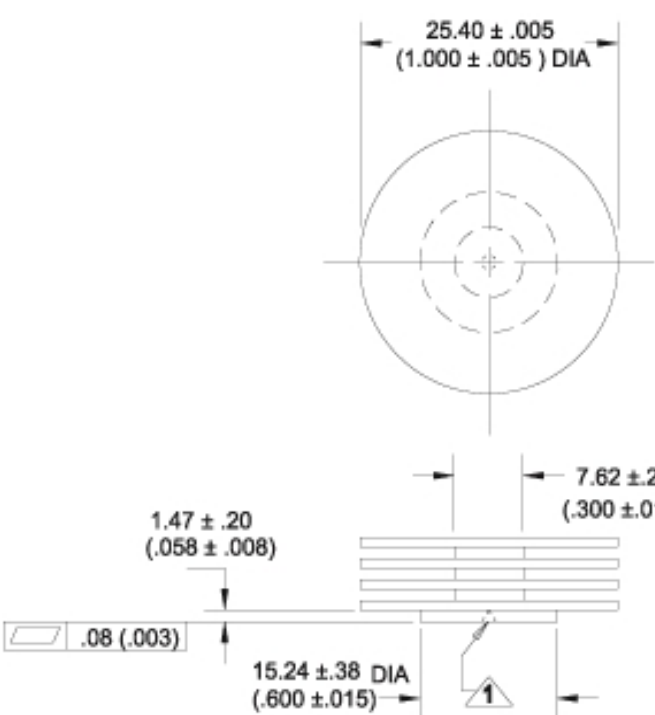
Part Number: 2283BG



Part Number: 2286BG<



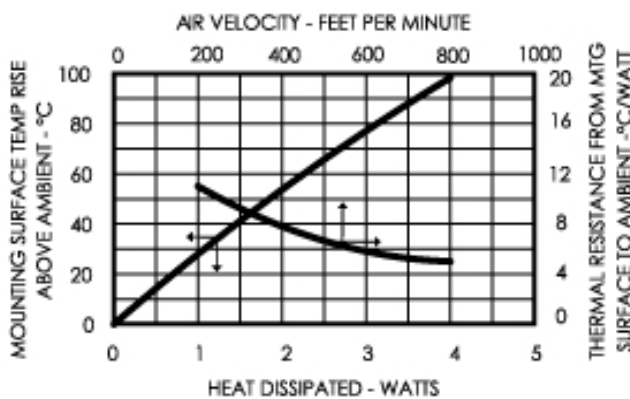
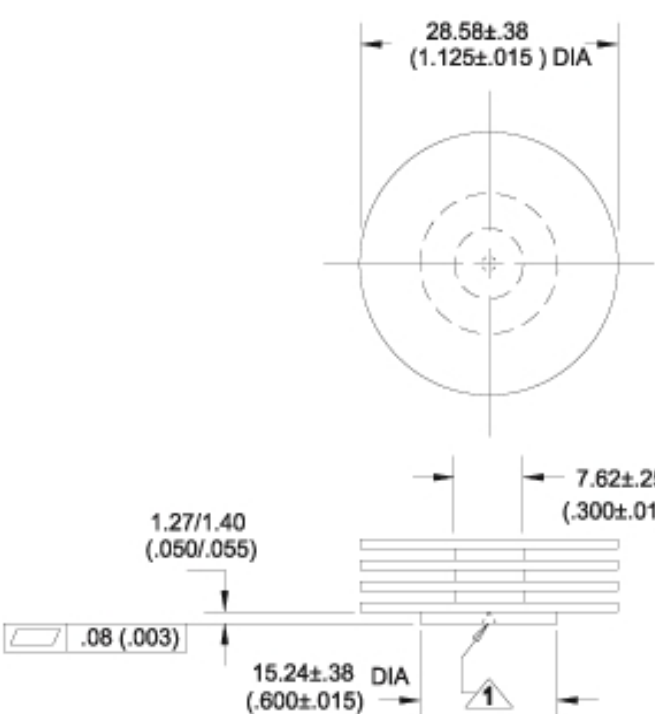
Part Number: 2288BG



Part Number: 2292BG



RoHS Compliant



Part Number: 2296BG

